Emerging & Low Dimensional Materials: [PHYS-789]

M. Elijah Wangeman

Spring 2024

Contents

L	Wednesday, January 17:	1
	1.0.1 Doping, Transistor Characteristics & FETs	1
	1.0.2 Logic Gates	1
	1.0.3 What are 2D & low dimensional materials?	2
1	Wednesday, January 17:	

1.0.1 Doping, Transistor Characteristics & FETs

- Doping: adding impurities to a semiconductor to change its electrical properties.
 - n-type: add electrons (donor)
 - p-type: add holes (acceptor)
- Transistor: a semiconductor device used to amplify or switch electronic signals and electrical power.
 - BJT: bipolar junction transistor
 - FET: field-effect transistor
- FET: a transistor in which current flows through a semiconductor channel whose width is modulated by an electric field.
 - MOSFET: metal-oxide-semiconductor field-effect transistor Family of curves: I_D vs V_{DS} for different values of V_{GS} Saturation: $V_{DS} > V_{GS} V_{TH}$

1.0.2 Logic Gates

• Inverter: $V_{out} = \text{inverse of } V_{in}$

1.0.3 What are 2D & low dimensional materials?

Crystalline single layer materials with thickness of a few atoms.

0D, 1D, 2D, 3D materials.

- 0D:
- 1D: Carbon nanotubes, nanowires.
- 2D: Graphene, transition metal dichalcogenides (TMDs), black phosphorus, hexagonal boron nitride (hBN).
- 3D: Bulk materials.